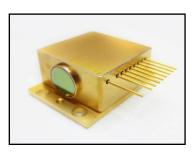
7.80 µm DISTRIBUTED FEEDBACK (DFB) QCL





HIGH HEAT LOAD (HHL) PACKAGE

OVERVIEW

- Thermo-electrically cooled. External heat sink still required.
- Sealed in a nitrogen-purged atmosphere.
- Package dimensions (approx): 1.75 x 1.25 x 0.72 in (excluding pins).

LASER SPECIFICATIONS

		Specs	Units
Process		DFB	
Oper. Temperature		15 – 45	°C
Facet Coating	Front	AR	
	Back	HR	

ELECTRO-OPTICAL CHARACTERIZATION

		Specs	Units
Driving Conditions	Operation Mode	CW	
	Temperature	15	°C
Electrical	Thresh. Current	0.26	Α
	Max. Current	0.64	Α
	Thresh. Voltage	8.7	V
	Max. Voltage	11.4	V
	Laser Efficiency	3.7	%
Optical	Max. Power Output	263.6	mW
	Center Wavelength	7.80	μm

SPECTRAL CHARACTERIZATION AND BEAM QUALITY

		Specs	Units
Driving Conditions	Operation Mode	CW	
Wavelength Tuning	Temperature	0.68	nm/K
	Current	68.1	nm/A
SMSR		30	dB
Beam Profile	Full Beam Waist	3.68	mm
	M ²	1.19	